



#### **Features**

- $\bullet$  High reliability LED package.
- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 500pcs/ Reel
- MSL (Moisture Sensitivity Level): 2
- Halogen-free
- RoHS compliant





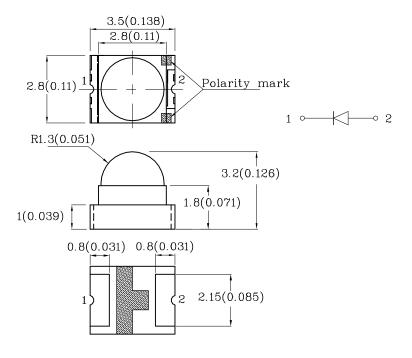


# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

### **Applications**

- Backlighting for tell-tale indicators
- Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- · Signs and signals
- Various applications requiring high temperature rating

## **Package Dimensions**



## Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.



Part Number: XZCM2ACY45W-2HTA

3.5 x2.8mm High Temperature Series

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (IF=2mA) mcd		Viewing Angle 20 1/2	
				Code.	Min.	Max.	
	Yellow	AlGaInP		VA*	80*	100*	
XZCM2ACY45W-2HTA			- -	VB* 100* 120*	120*		
			Water Clear - -	WA*	120*	150*	40°
				WB*	150*	180*	40
				XA*	180*	215*	
				XB*	215*	250*	

#### Note:

## Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power dissipation	PD	75	mW
Junction temperature	TJ	115	°C
Reverse Voltage	VR	5	V
Operating Temperature	Тор	-40 To +100	°C
Storage Temperature	Tstg	-40 To +115	°C
DC Forward Current	IF	30	mA
Peak Forward Current [2]	IFM	140	mA
Electrostatic Discharge Threshold (HBM)		3000	V
Thermal Resistance (Junction/ambient) [1]	Rth j-a	740	°C/W
Thermal Resistance (Junction / Solder point) [1]	Rth j-s	600	°C/W

#### Notes:

## Electrical / Optical Characteristics at Ta=25°C

P	Symbol	Value				TT **
Parameter		Code.	Min.	Typ.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF = 2mA	λ peak		-	590*		nm
		3*	586*	-	588*	
Dominant Wavelength CIE127-2007* IF = 2mA	λ dom [1]	4*	588*	-	590*	nm
		5*	590*	-	592*	
Spectral bandwidth at 50% Frel MAX If = 2mA	Δλ	-	-	20		nm
Forward Voltage IF = 2mA	VF [2]	-	-	1.85	2.2	V
Reverse Current VR = 5V	IR	-	-	-	10	μА
Temperature coefficient of $\lambda$ peak IF = 2mA,-10°C $\leq$ T $\leq$ 100°C	TC λ peak	-	-	0.12	-	nm/°C
Temperature coefficient of $\lambda dom$ IF = 2mA,-10°C $\leq$ T $\leq$ 100°C	TC λ dom	-	-	0.07	-	nm/°C
Temperature coefficient of VF $I_F = 2mA, -10^{\circ}C \leq T \leq 100^{\circ}C$	TCv	-	-	-2.0	-	mV/°C

#### Notes:

<sup>1.01/2</sup> is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

<sup>\*</sup>Luminous intensity value is in accordance with CIE127-2007 standards.

<sup>1.</sup> Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),

<sup>2. 1/10</sup> Duty Cycle, 0.1ms Pulse Width.

<sup>3.</sup> A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

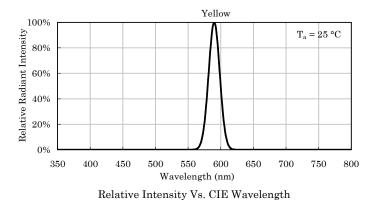
<sup>1.</sup> Wavelength: +/-1nm.

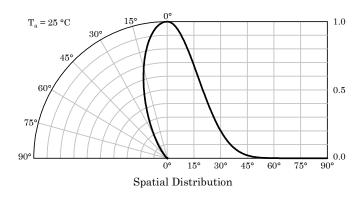
<sup>2.</sup> Forward Voltage: +/-0.1V.

 $<sup>\</sup>mbox{*}$  Wavelength value is in accordance with CIE127-2007 standards.

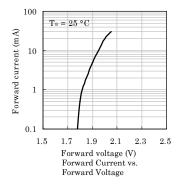


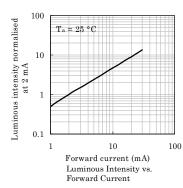


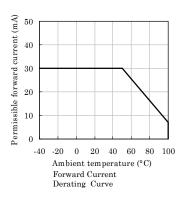


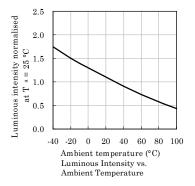


### **❖** Yellow



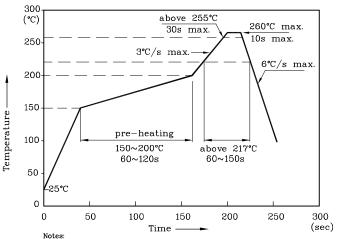






# LED is recommended for reflow soldering and soldering profile is shown below.

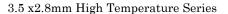
Reflow Soldering Profile for SMD Products (Pb-Free Components)



- 1. All temperatures refer to the center of the package, measured on the package body surface facing up during reflow
- 2. Do not apply any stress to the LED during high temperature conditions.

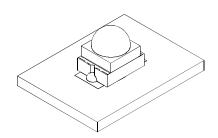
  3. Maximum number of soldering passes: 2



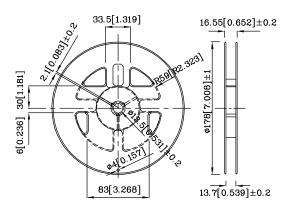




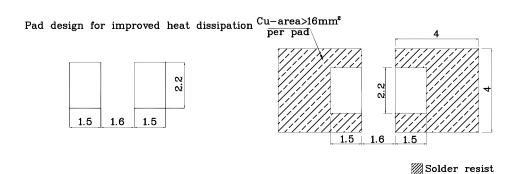
♦ The device has a single mounting surface. The device must be mounted according to the specifications.



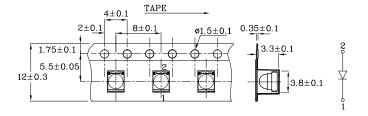
### **Reel Dimension**



## Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)



\* Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

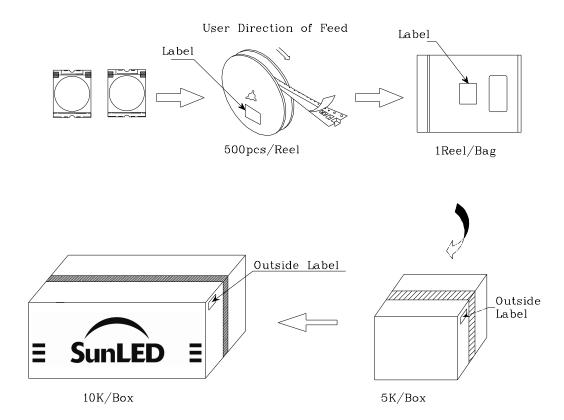
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage:  $\pm$ -0.1V

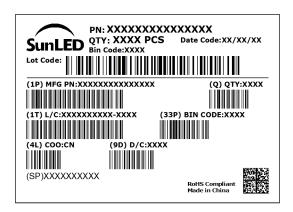
Note: Accuracy may depend on the sorting parameters.





### PACKING & LABEL SPECIFICATIONS





#### TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below

## Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	$T_a$ = 25°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100 (101)	$T_a$ = 100°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	$T_a$ = -40°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100 (201)	$T_a$ = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100 (202)	T <sub>a</sub> = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100 (103)	$T_a = 60$ °C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100 (102)	$T_a$ = 60°C, RH = 90% $I_F$ = maximum rated current *	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100 (301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$T_a$ = -40°C(15min) ~ 100°C(15min) $I_F$ = derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	$T_a$ = -40°C(15min) ~ maximum rated Storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100 (304)	$C = 100 pF$ , $R2 = 1.5 K\Omega$ $V = 3000 V$	Once each Polarity	0 / 22
12	Vibration test	-	$a = 196 \text{m/s}^2$ , $f = 100 \sim 2 \text{KHz}$ , $t = 48 \text{min for all xyz axes}$	4 times	0 / 22

<sup>\*:</sup> Refer to forward current vs. derating curve diagram

## Criteria for Judging Damage

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	$I_F = 2mA$	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	$I_F = 2mA$	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	IR	V <sub>R</sub> = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	_	Occurrence of notable decoloration, deformation and cracking